TPCA8121

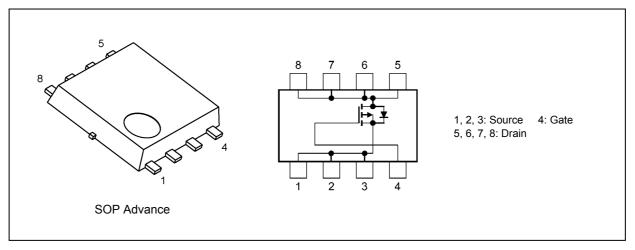
1. Applications

- Lithium-Ion Secondary Batteries
- Power Management Switches

2. Features

- (1) Small, thin package
- (2) Low drain-source on-resistance: $R_{DS(ON)} = 2.4 \text{ m}\Omega \text{ (typ.)} (V_{GS} = -10 \text{ V})$
- (3) Low leakage current: $I_{DSS} = -10 \ \mu A \ (max) \ (V_{DS} = -30 \ V)$
- (4) Enhancement mode: V_{th} = -0.8 to -2.0 V (V_{DS} = -10 V, I_D = -1 mA)

3. Packaging and Internal Circuit



4. Absolute Maximum Ratings (Note) ($T_a = 25^{\circ}C$ unless otherwise specified)

Characteri	Symbol	Rating	Unit		
Drain-source voltage			V _{DSS}	-30	V
Drain-gate voltage	(R _{GS} = 20 kΩ)		V _{DGR}	-30	
Gate-source voltage			V _{GSS}	-20/+10	
Drain current (DC)		(Note 1)	Ι _D	-45	A
Drain current (pulsed)		(Note 1)	I _{DP}	-135	
Power dissipation	(T _c = 25°C)		PD	45	W
Power dissipation	(t = 10 s)	(Note 2)	PD	2.8	W
Power dissipation	(t = 10 s)	(Note 3)	PD	1.6	W
Single-pulse avalanche energy		(Note 4)	E _{AS}	263	mJ
Avalanche current			I _{AR}	-45	A
Channel temperature		(Note 5)	T _{ch}	175	°C
Storage temperature			T _{stg}	-55 to 150	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

5. Thermal Characteristics

Characteris	Symbol	Max	Unit		
Channel-to-case thermal resistance	(T _c = 25°C)		R _{th(ch-c)}	2.78	°C/W
Channel-to-ambient thermal resistance	(t = 10 s)	(Note 2)	R _{th(ch-a)}	44.6	°C/W
Channel-to-ambient thermal resistance	(t = 10 s)	(Note 3)	R _{th(ch-a)}	78.1	°C/W

Note 1: Ensure that the channel temperature does not exceed 175°C.

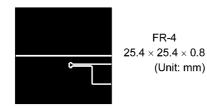
Note 2: Device mounted on a glass-epoxy board (a), Figure 5.1

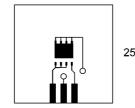
Note 3: Device mounted on a glass-epoxy board (b), Figure 5.2

Note 4: V_{DD} = -24 V, T_{ch} = 25°C (initial), L = 100 μ H, R_G = 25 Ω , I_{AR} = -45 A

Note 5: Merely Channel temperature is guaranteed 175°C.

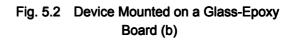
Storage temperature range is guaranteed as usual (-55 to 150°C).





FR-4 25.4 × 25.4 × 0.8 (Unit: mm)

Fig. 5.1 Device Mounted on a Glass-Epoxy Board (a)



Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

6. Electrical Characteristics

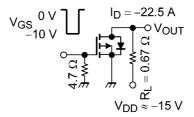
6.1. Static Characteristics (T_a = 25°C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current	I _{GSS}	V _{GS} = -20/+10 V, V _{DS} = 0 V	_	_	±100	nA
Drain cut-off current	I _{DSS}	V _{DS} = -30 V, V _{GS} = 0 V	_	_	-10	μA
Drain-source breakdown voltage	V _{(BR)DSS}	I _D = -10 mA, V _{GS} = 0 V	-30		_	V
Drain-source breakdown voltage (Note 6)	V _{(BR)DSX}	I _D = -10 mA, V _{GS} = 10 V	-21	_	_	
Gate threshold voltage	V _{th}	V _{DS} = -10 V, I _D = -1 mA	-0.8	_	-2.0	
Drain-source on-resistance	R _{DS(ON)}	V _{GS} = -4.5 V, I _D = -22.5 A	_	3.1	4.0	mΩ
		V _{GS} = -10 V, I _D = -22.5 A	_	2.4	3.0	

Note 6: If a reverse bias is applied between gate and source, this device enters V_{(BR)DSX} mode. Note that the drainsource breakdown voltage is lowered in this mode.

6.2. Dynamic Characteristics ($T_a = 25^{\circ}C$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance	C _{iss}	V _{DS} = -10 V, V _{GS} = 0 V, f = 1 MHz	_	7420	_	pF
Reverse transfer capacitance	C _{rss}		—	1180	_	
Output capacitance	C _{oss}		_	1440	—	
Switching time (rise time)	t _r	See Figure 6.2.1.	_	10	_	ns
Switching time (turn-on time)	t _{on}			18	_	
Switching time (fall time)	t _f			262	_	
Switching time (turn-off time)	t _{off}		_	762	_	



Duty \leq 1%, t_{W} = 10 μs

Fig. 6.2.1 Switching Time Test Circuit

6.3. Gate Charge Characteristics ($T_a = 25^{\circ}C$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Qg	$V_{DD} \approx$ -24 V, V_{GS} = -10 V, I_D = -45 A	—	190	—	nC
Gate-source charge 1	Q _{gs1}		_	23	_	
Gate-drain charge	Q _{gd}			47	_	

6.4. Source-Drain Characteristics ($T_a = 25^{\circ}C$ unless otherwise specified)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Reverse drain current (pulsed)	(Note 7)	I _{DRP}	—	_	_	-135	А
Diode forward voltage		V _{DSF}	I _{DR} = -45 A, V _{GS} = 0 V	_		1.2	V

Note 7: Ensure that the channel temperature does not exceed 175°C.

7. Marking

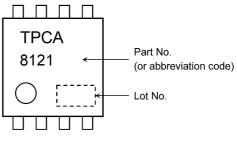
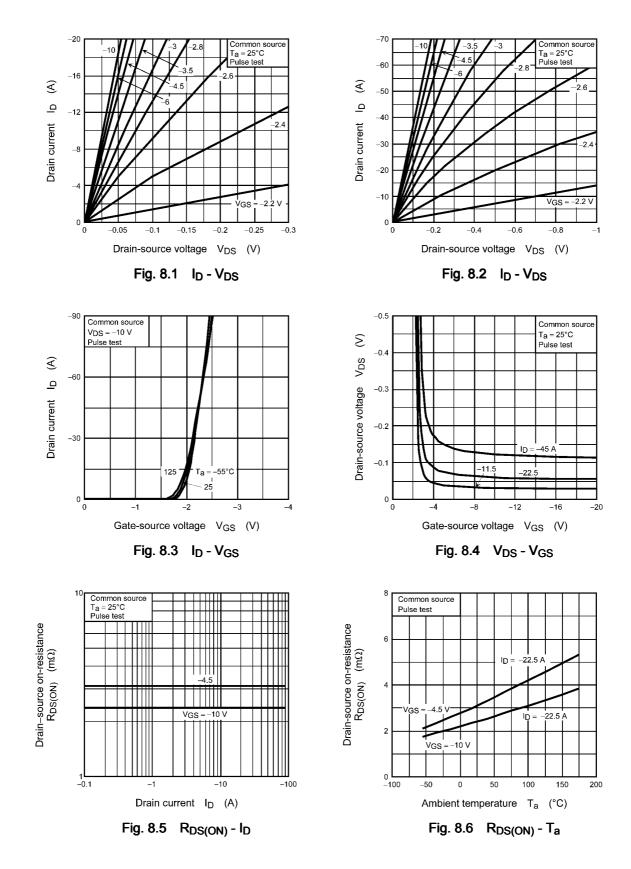
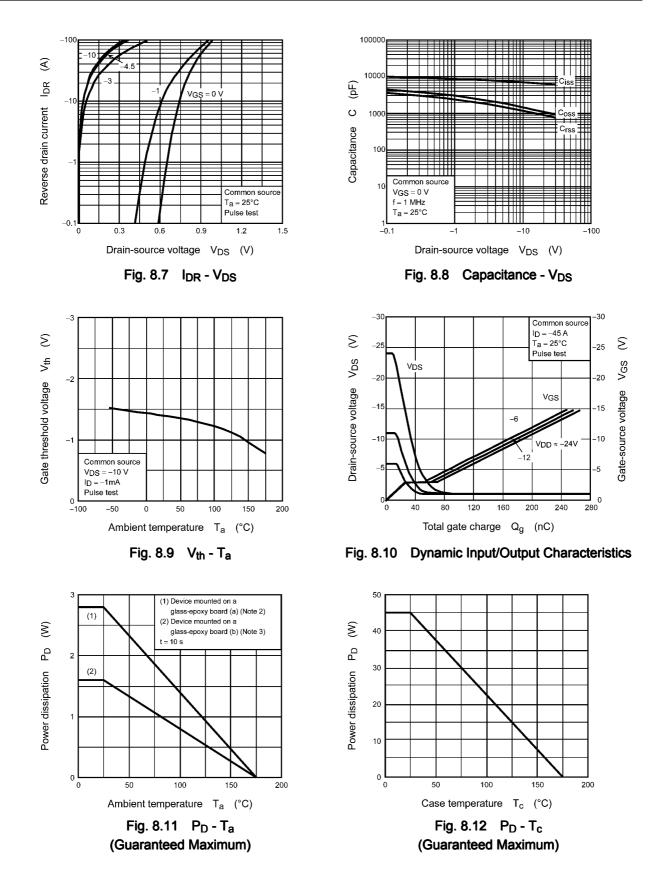
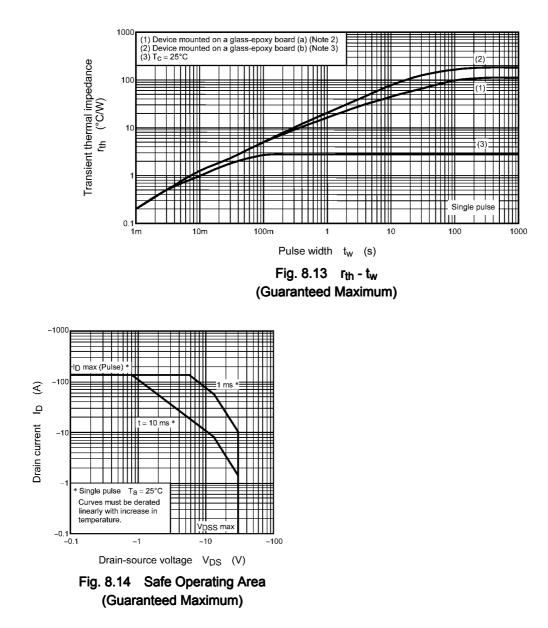


Fig. 7.1 Marking

8. Characteristics Curves (Note)





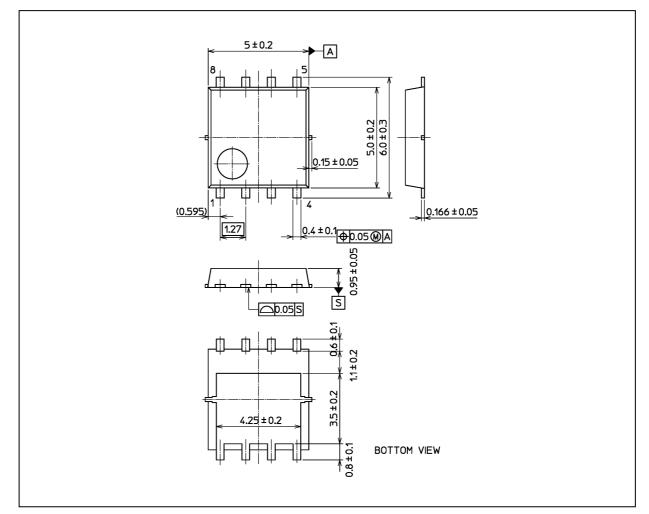


Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

TPCA8121

Package Dimensions

Unit: mm



Weight: 0.069 g (typ.)

Package Name(s)

TOSHIBA: 2-5Q1S

Nickname: SOP Advance

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